

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ZHONGDE SHAN	03/08/2013
XIWEN LI	03/08/2013
FENG LIU	03/08/2013
JUANJUAN QIAO	03/08/2013
HAIBO CHEN	03/08/2013
SHAOYAN QIN	03/08/2013
RECEIVING PARTY DATA	
Name:	ADVANCED MANUFACTURE TECHNOLOGY CENTER, CHINA ACADEMY OF MACHINERY SCIENCE & TECHNOLOGY
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City:	BEIJING
State/Country:	CHINA
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14369630
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NAME OF SUBMITTER:	JAYE G HEYBL
SIGNATURE:	/jgh/
DATE SIGNED:	06/27/2014

Total Attachments: 2

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ASSIGNMENT WITHOUT NOTARIZATION

WHEREAS, we, SHAN, Zhongde; LI, Xiwen; LIU, Feng; QIAO, Juanjuan; CHEN, Haibo and QIN, Shaoyan residing at No.18 Xueqing Road, Haidian District, Beijing, 100083, China made certain new and useful inventions and improvements for which we filed an application for Letters Patent of the United States on June 27, 2014, application Serial No. 14/369,630, which is entitled Multi-dimensional weaving shaping machine of composite material.

AND WHEREAS, ADVANCED MANUFACTURE TECHNOLOGY CENTER, CHINA ACADEMY OF MACHINERY SCIENCE & TECHNOLOGY a corporation organized and existing under and by virtue of the laws of P.R. China, and having an office and place of business at 18 Xueqing Road, Haidian District, Beijing, 100083, China (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW THEREFORE, to all whom it may concern, be it known that for and in consideration of the sum of One Dollar and other good and valuable considerations, the receipt and sufficiency whereof is hereby acknowledged, we have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted therefrom; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the Assignee, its successors and assigns.

AND, for the consideration aforesaid, we do hereby agree that we and our executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and

to the improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore we covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by us and that full right to convey the same as herein expressed is possessed by us.

SHAN, Zhongde

2013.3.8

Signature of Inventor #1

Date

NAME: SHAN, Zhongde

LI, Xiwen

2013.3.8

Signature of Inventor #2

Date

NAME: LI, Xiwen

LIU, Feng

2013.3.8

Signature of Inventor #3

Date

NAME: LIU, Feng

QIAO, Juanjuan

2013.3.8

Signature of Inventor #4

Date

NAME: QIAO, Juanjuan

CHEN, Haibo

2013.3.8

Signature of Inventor #5

Date

NAME: CHEN, Haibo

QIN, Shaoyan

2013.3.8

Signature of Inventor #6

Date

NAME: QIN, shaoyan